

L Number	Hits	Search Text	DB	Time stamp
11	4	6429506.URPN.	USPAT	2004/09/02 17:41
12	2	6245593.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/02 17:51
13	7	("4921564"   "5435876"   "5597767"   "5759874"   "5824177"   "5843251"   "5976691").PN.	USPAT	2004/09/02 17:45
14	5	6245593.URPN.	USPAT	2004/09/02 17:48
16	0	((cap with cavity) and (mem or (micro adj electromechanical)) and (@ad<20001205 or @rlad<20001205)) and (transfer adj tape) and (dicing adj tape)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/02 17:53
17	0	((cap with cavity) and (mem or (micro adj electromechanical)) and (@ad<20001205 or @rlad<20001205)) and (dicing adj tape)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/02 17:53
15	110	(cap with cavity) and (mem or (micro adj electromechanical)) and (@ad<20001205 or @rlad<20001205)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/02 17:53
-	6	(dicing adj tape) same (transfer tape) same (etched adj ports)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/02 14:46
-	6	(dicing adj tape) with (through adj hole) with backside	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 18:10
-	13	("4791075"   "4907065"   "5150196"   "5323051"   "5362681"   "5435876"   "5610431"   "5824177"   "5831162"   "6106735"   "6109113"   "6210514"   "6410360").PN.	USPAT	2003/11/12 18:09
-	6	(dicing adj tape) same (through adj hole) same backside	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 18:11
-	12	(dicing adj tape) and ((hole or via or open\$3 or interconnect) with (substrate or wafer)) and (transfer adj tape)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 18:39
-	194	(dicing adj tape) and ((hole or via or open\$3 or interconnect) with (substrate or wafer))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 18:40
-	53	(dicing adj tape) same ((hole or via or open\$3 or interconnect) with (substrate or wafer))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 18:42
-	20	((dicing adj tape) same ((hole or via or open\$3 or interconnect) with (substrate or wafer))) and @ad<20001205	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 19:00
-	26	(dicing adj tape) with wafer with backside	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 18:58
-	148	tape with wafer with backside	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 18:59
-	246	tape with (wafer or substrate) with backside	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 18:59

-	1713	(hole or open\$3 or via or interconnect) with (wafer or substrate) with backside	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 19:00
-	38	(tape with (wafer or substrate) with backside) and ((hole or open\$3 or via or interconnect) with (wafer or substrate) with backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 19:00
-	22	((tape with (wafer or substrate) with backside) and ((hole or open\$3 or via or interconnect) with (wafer or substrate) with backside)) and dic\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 19:00
-	6	((((tape with (wafer or substrate) with backside) and ((hole or open\$3 or via or interconnect) with (wafer or substrate) with backside)) and dic\$3) and @ad<20001205	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/12 19:00
-	2	5362681.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 11:56
-	56	5362681.URPN.	USPAT	2003/11/13 11:53
-	6315	((bottom or (back adj side)) with (tape or adhesive)) same (dic\$3 or cut\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 11:57
-	469	((bottom or (back adj side)) with (tape or adhesive) with (wafer or substrate)) same (dic\$3 or cut\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 11:58
-	257327	(wafer or substrate) with (via hole open\$3 interconnect)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 11:59
-	80	((((bottom or (back adj side)) with (tape or adhesive) with (wafer or substrate)) same (dic\$3 or cut\$4)) same ((wafer or substrate) with (via hole open\$3 interconnect)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 14:27
-	0	(((((bottom or (back adj side)) with (tape or adhesive) with (wafer or substrate)) same (dic\$3 or cut\$4)) same ((wafer or substrate) with (via hole open\$3 interconnect)))) and 5362681.URPN.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 11:59
-	8	5362681.URPN. and (((bottom or (back adj side)) with (tape or adhesive) with (wafer or substrate)) same (dic\$3 or cut\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 16:29
-	1	007585.apn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 12:12
-	43	(((((bottom or (back adj side)) with (tape or adhesive) with (wafer or substrate)) same (dic\$3 or cut\$4)) same ((wafer or substrate) with (via hole open\$3 interconnect)))) and @ad<20001205	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 12:12
-	15	("4872825"   "4933744"   "5178957"   "5497033"   "5685885"   "5730922"   "5747101"   "5761801"   "5766979"   "5848467"   "5866952"   "5958995"   "5962608"   "5971253"   "6007407").PN.	USPAT	2003/11/13 12:35
-	344	((((bottom or (back adj side)) with (tape or adhesive) with (wafer or substrate)) same (dic\$3 or cut\$4)) and ((wafer or substrate) with (bottom or (back adj side) with etch\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 14:29

-	323	((bottom or (back adj side)) with (tape or adhesive) with (wafer or substrate)) same (dic\$3 or cut\$4)) same ((wafer or substrate) with (bottom or (back adj side) with etch\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 14:29
-	64	((bottom or (back adj side)) with (tape or adhesive) with (wafer or substrate)) same (dic\$3 or cut\$4)) same ((wafer or substrate) with (bottom or (back adj side) with etch\$3))) and 438/\$3.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:20
-	28	((bottom or (back adj side)) with (tape or adhesive) with (wafer or substrate)) same (dic\$3 or cut\$4)) same ((wafer or substrate) with (bottom or (back adj side) with etch\$3))) and 438/\$3.ccls.) and @ad<20001205	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:31
-	8	uv with tape with needle	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 16:31
-	11	(uv with tape) same needle	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 16:33
-	10	(ultraviolet with tape) same needle	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 16:39
-	72	(ultraviolet with adhesive) same needle	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 16:40
-	6	((ultraviolet with adhesive) same needle) same dic\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:03
-	7	(transfer adj tape) with (dicing adj tape)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 19:04
-	1389	(transfer adj tape) with (adhesive)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:30
-	6	((transfer adj tape) with (adhesive)) with dicing	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:05
-	6	((transfer adj tape) with (adhesive)) same dicing	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:05
-	11	(transfer adj tape) with dicing	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:06
-	7	(transfer adj tape) same (dicing adj tape)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:28
-	15	((transfer adj tape) with (adhesive)) and 438/\$3.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:30
-	0	(pickup adj tape) same (dicing adj tape)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:28
-	2	(pickup adj tape) and (dicing adj tape)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:28

-	236	(dicing adj tape) with (adhesive)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:30
-	70	((dicing adj tape) with (adhesive)) and 438/\$3.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:31
-	24	((dicing adj tape) with (adhesive)) and 438/\$3.ccls.) and @ad<20001205	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 17:31
-	6	(releas\$3 adj tape) with (dicing adj tape)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/13 19:05
-	1	006966.apn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/11/14 11:34
-	0	((dic\$3 adj tape) same (mem or mems)) and (@ad<20001205 or @rlad<20001205)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/26 15:24
-	11	(dic\$3 adj tape) same (mem or mems)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/26 15:24
-	13	("4791075"   "4907065"   "5150196"   "5323051"   "5362681"   "5435876"   "5610431"   "5824177"   "5831162"   "6106735"   "6109113"   "6210514"   "6410360").PN.	USPAT	2004/04/26 15:15
-	26	(dic\$3 adj tape) and (mem or mems)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/26 15:24
-	11	((dic\$3 adj tape) and (mem or mems)) and (@ad<20001205 or @rlad<20001205)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/26 16:37
-	132	438/45\$1.ccls. and (mems or mem)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/26 16:37
-	75	(438/45\$1.ccls. and (mems or mem)) and (@ad<20001205 or @rlad<20001205)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/26 16:37
-	1	((438/45\$1.ccls. and (mems or mem)) and (@ad<20001205 or @rlad<20001205)) and (dic\$3 with tape)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/26 16:50
-	4	((438/45\$1.ccls. and (mems or mem)) and (@ad<20001205 or @rlad<20001205)) and tape	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/04/26 16:50
-	8	("5187007"   "5476566"   "5605489"   "5923995"   "6010782"   "6245593"   "6297131"   "6320266").PN.	USPAT	2004/04/26 17:05
-	77	((wafer adj cap) or tape) with cavity) and (mem or (micro adj electromechanical))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/02 14:59
-	2	6429506.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/02 17:45
-	50	((((wafer adj cap) or tape) with cavity) and (mem or (micro adj electromechanical))) and (@ad<20001205 or @rlad<20001205)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/09/02 17:51

-	15	("4921564"   "5362681"   "5435876"   "5597767"   "5824177"   "6107685"   "6124637"   "6313532"   "6198165"   "6201707"   "6204564"   "6208525"   "6165885"   "6232650"   "6291895") .PN.	USPAT	2004/09/02 15:55
---	----	--	-------	---------------------